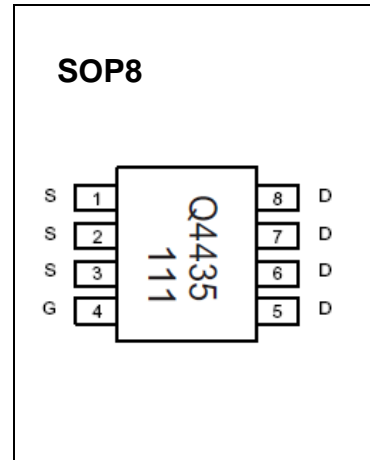
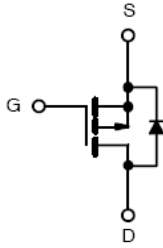


SOP8 Plastic-Encapsulate MOSFETS

CJQ4435 P-Channel MOSFET

APPLICATIONS

- Load Switches
- Battery Switch



Maximum ratings (T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Units
Drain-Source Voltage	V _{DS}	-30	V
Gate-Source Voltage	V _{GS}	±20	
Continuous Drain Current (t =10s) (note 1)	I _D	-9.1	A
Pulsed Drain Current	I _{DM}	-50	
Drain-Source Diode Forward Current (t =10s) (note 1)	I _S	-2	
Power Dissipation (t =10s)	P _D	1.4	W
Thermal Resistance from Junction to Ambient (t ≤10s) (note 1)	R _{θJA}	89	°C/W
Junction Temperature	T _J	150	°C
Storage Temperature	T _{stg}	-55 ~+150	

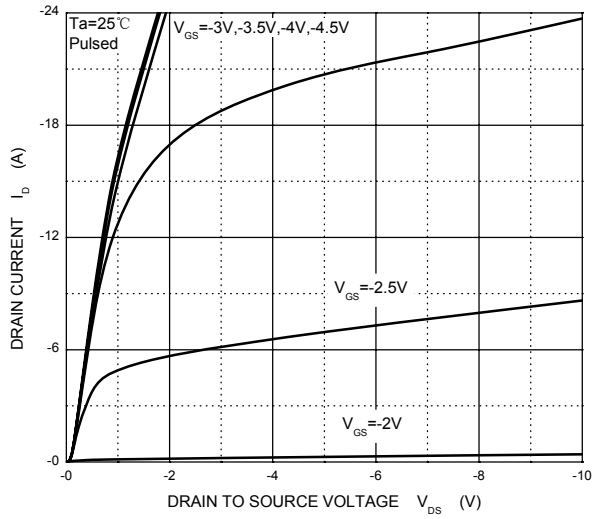
Electrical characteristics ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-30V, V_{GS}=0V$			-1	μA
Gate body Leakage	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1		-3	V
Drain-Source on-state Resistance (note 2)	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-9.1A$			24	m Ω
		$V_{GS}=-4.5V, I_D=-6.9A$			35	
Forward Transconductance (note 2)	g_{FS}	$V_{DS}=-10V, I_D=-9.1A$	20			S
Dynamic Characteristics (note 3)						
Input Capacitance	C_{iss}	$V_{DS}=-15V, V_{GS}=0V, f=1MHz$		1350		pF
Output Capacitance	C_{oss}			215		
Reverse Transfer Capacitance	C_{rss}			185		
Total Gate Charge	Q_g	$V_{DS}=-15V, V_{GS}=-10V, I_D=-9.1A$			50	nC
					25	
Gate-Source Charge	Q_{gs}	$V_{DS}=-15V, V_{GS}=-4.5V, I_D=-9.1A$		4		
Gate-Drain Charge	Q_{gd}			7.5		
Gate Resistance	R_g	$f=1MHz$		5.8		Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=-15V, R_L=15\Omega$ $I_D=-1A, V_{GEN}=-10V, R_G=1\Omega$			15	ns
Rise Time	t_r				15	
Turn-Off Delay Time	$t_{d(off)}$				70	
Fall Time	t_f				25	
Drain-Source Body Diode Characteristics						
Diode Forward Voltage	V_{SD}	$I_S=-2A, V_{GS}=0V$			-1.2	V

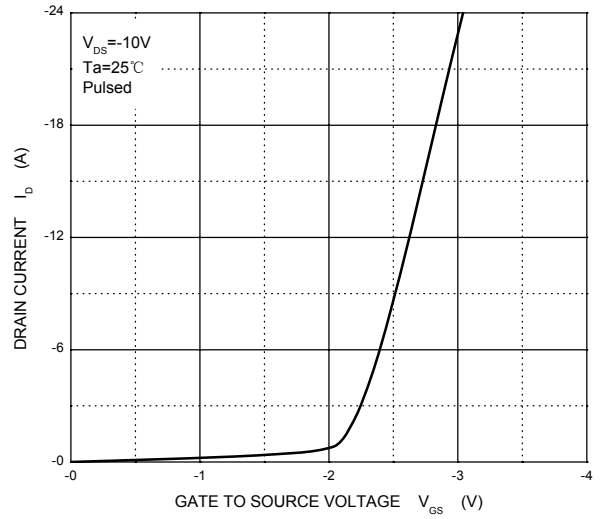
Notes:

1. Surface mounted on 1"×1" FR4 board.
2. Pulse Test : Pulse Width≤300 μs , Duty Cycle ≤2%.
3. Guaranteed by design, not subject to production testing.

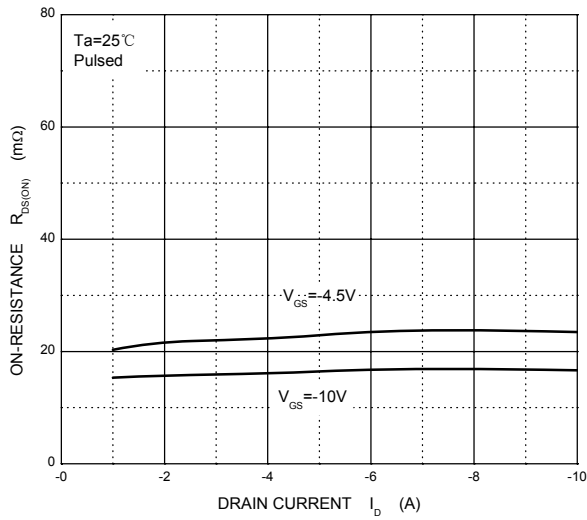
Output Characteristics



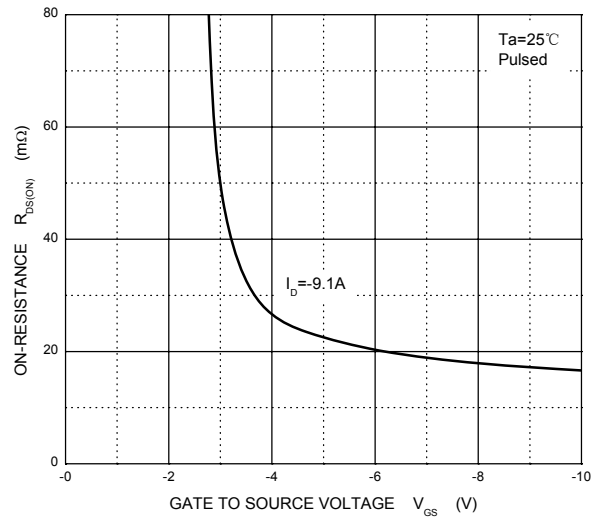
Transfer Characteristics



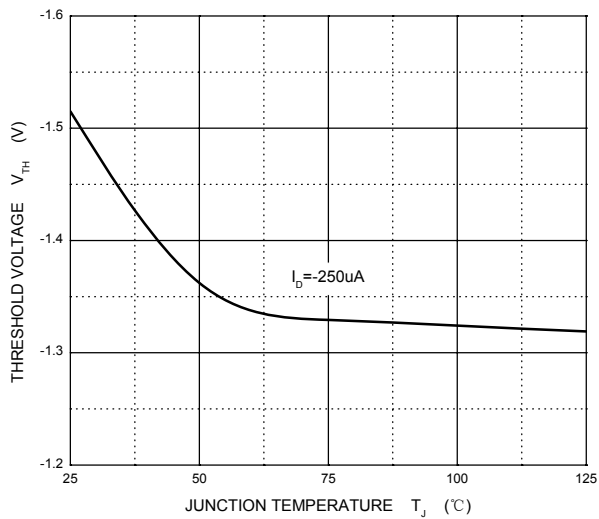
$R_{DS(ON)}$ — I_D



$R_{DS(ON)}$ — V_{GS}



Threshold Voltage



I_S — V_{SD}

